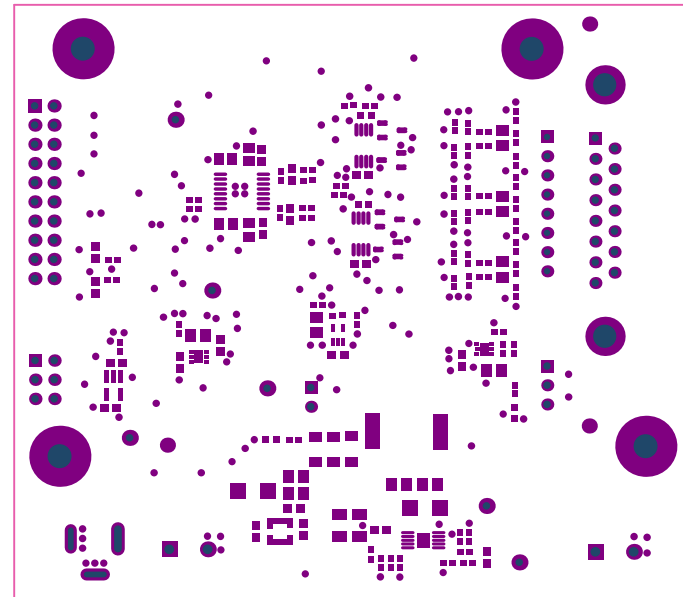
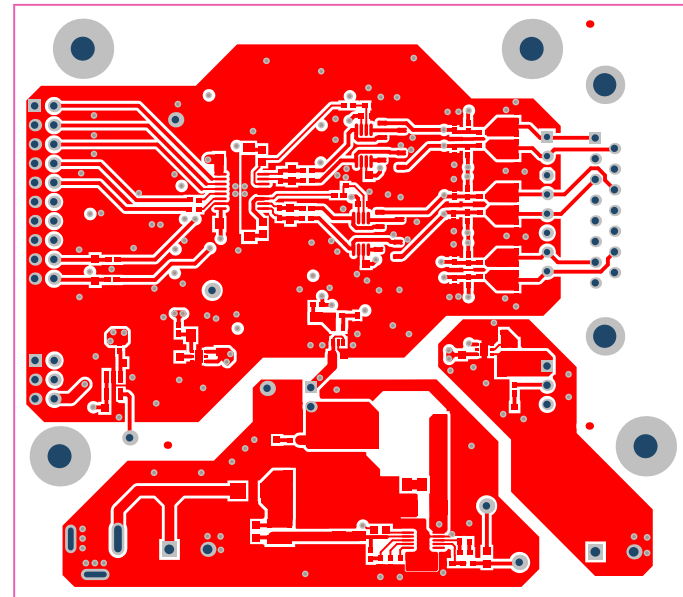


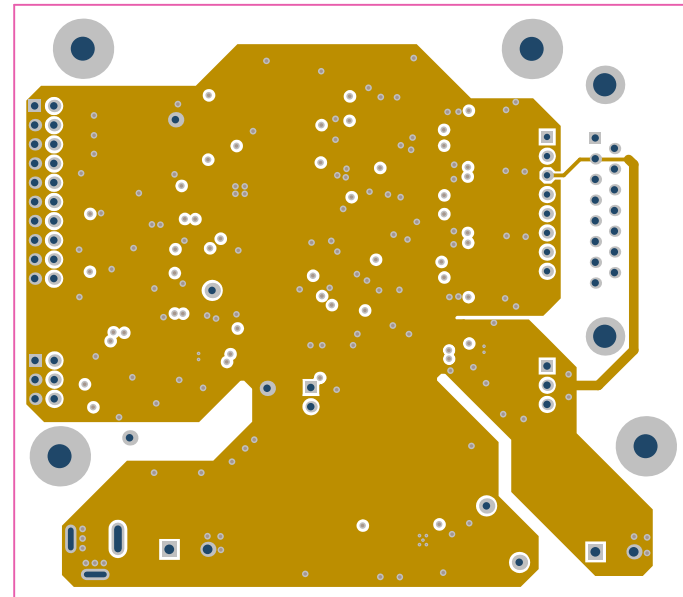
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00176	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 6/3/2015	10:13:33 AM	TEXAS INSTRUMENTS



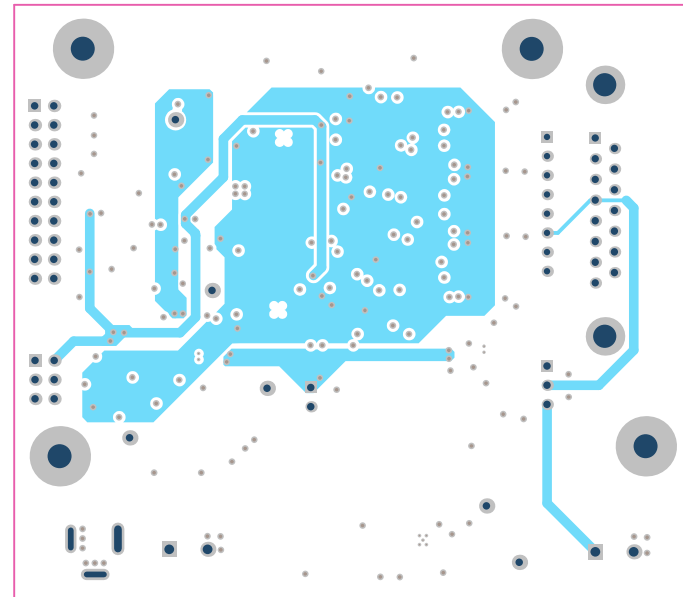
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00176	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 6/3/2015 10:13:35 AM	TEXAS INSTRUMENTS	



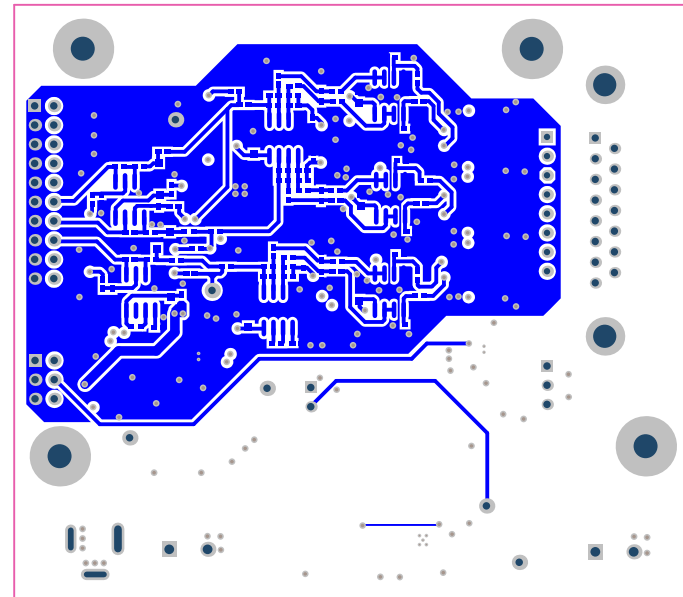
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00176	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 6/3/2015 10:13:36 AM	TEXAS INSTRUMENTS	



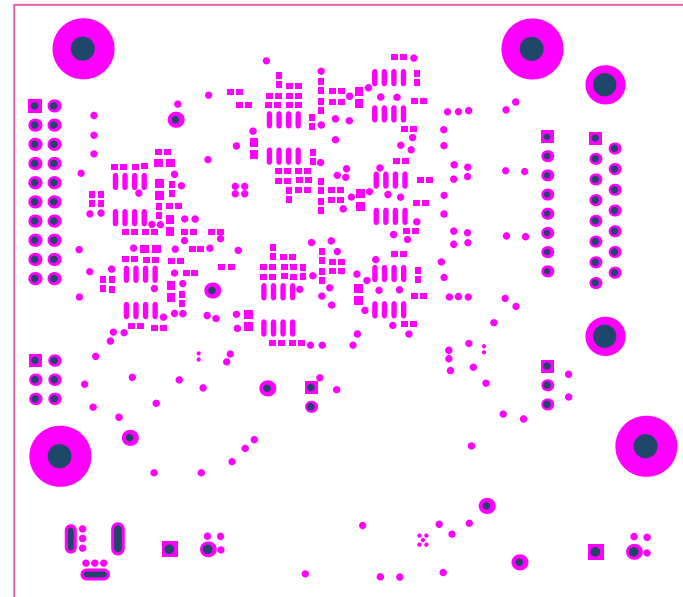
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00176	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = MidLayer1	GENERATED : 6/3/2015 10:13:37 AM	TEXAS INSTRUMENTS	



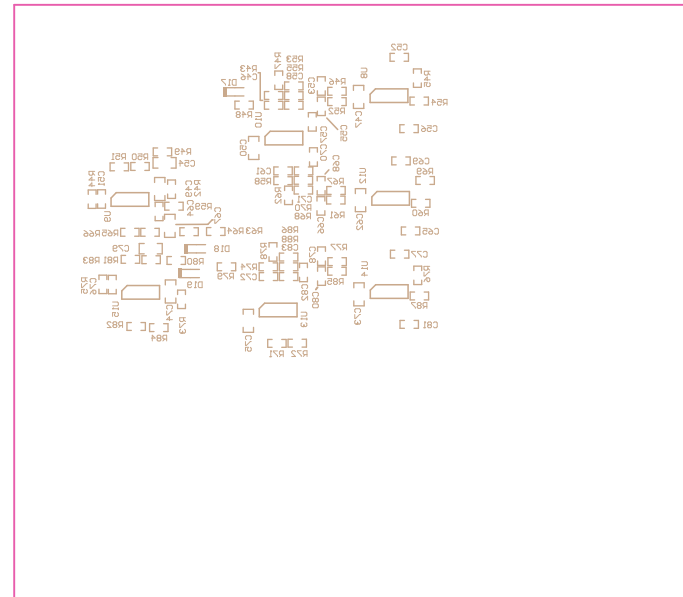
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00176	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = MidLayer2	GENERATED : 6/3/2015 10:13:38 AM	TEXAS INSTRUMENTS	



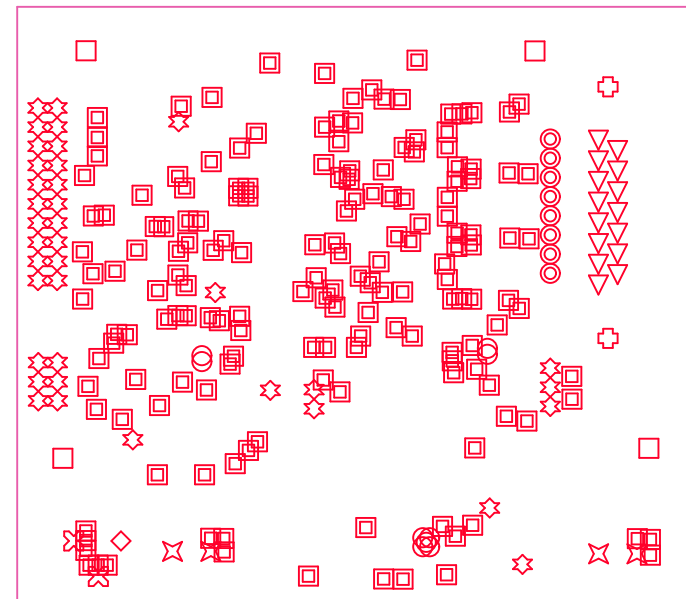
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00176	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 6/3/2015 10:13:39 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00176	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 6/3/2015 10:13:40 AM	TEXAS INSTRUMENTS	

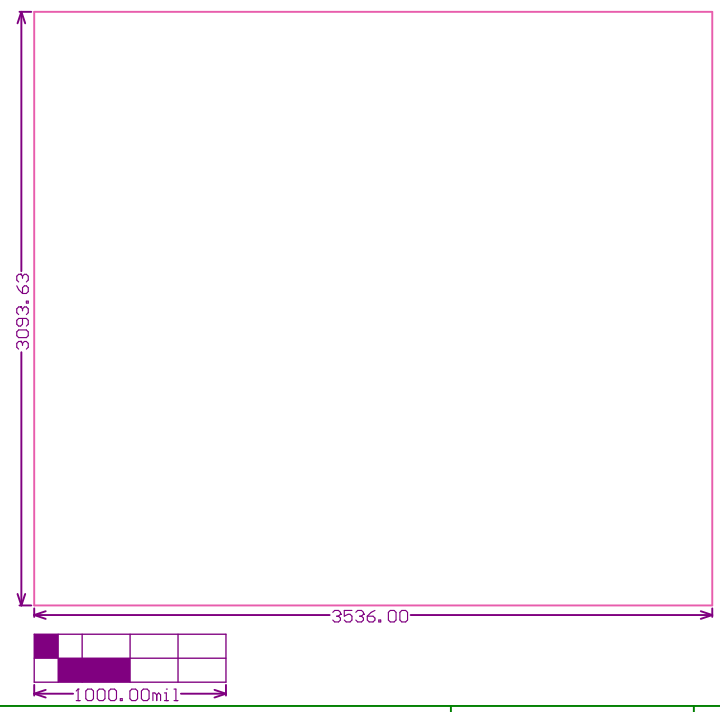


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00176	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 6/3/2015	10:13:42 AM	TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	9	7.87mil (0.200mm)	PTH	Round
■	169	19.69mil (0.500mm)	PTH	Round
●	8	33.46mil (0.850mm)	PTH	Round
▽	15	39.37mil (1.000mm)	PTH	Round
☆	37	40.00mil (1.016mm)	PTH	Round
✕	4	51.18mil (1.300mm)	PTH	Round
⊗	2	122.05mil (3.100mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
⊗	2	29.92mil (0.760mm)	PTH	Slot
◇	1	39.76mil (1.010mm)	PTH	Slot
	251 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00176	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 6/3/2015	10:13:43 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00176	REV: Rev E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 6/3/2015	10:13:44 AM	TEXAS INSTRUMENTS

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